



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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RTV Silicones



Technical Support
for RTV Silicones

1-800-255-8886

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2-Part Potting/Encapsulating Compound RTV12

STOCKED ITEM

BUY NOW

Primary Characteristics

- ▶ Clear flowable
- ▶ Primerless adhesion
- ▶ Condensation cure
- ▶ General purpose potting
- ▶ Room temp. cure
- ▶ Requires parts A and C

Use for :

- ▶ General purpose potting requiring clear, room temp. cure
- ▶ Applications where primerless adhesion is desired

A clear, two component, low viscosity potting compound that cures at room temperature to a soft pliable rubber. Will cure in deep sections. Designed to achieve primerless adhesion to many substrates, including metals, plastics, and ceramics. The excellent electrical properties make it a candidate material for both high and low voltage electrical assemblies. Cushions against mechanical shock and vibration. RTV12 is clear enough to allow visual observation of components during pouring. After cure, the clarity lends to easy identification, repair and replacement of components.

Available Sizes

Catalog Number	Sizes Available	Description
RTV12A-1G	9.5 lbs.	Pail
RTV12C-1P	1 pint	Catalyst for RTV12, pail

Specifications

Use	General Purpose Potting
Special Feature	Cushions against mechanical shock
Cross Reference	RTV12
Uncured Properties	
Consistency	Flowable
Color	Clear (translucent)
Specific Gravity	1.00
Pot Life (@ 25°C / 77°F)	1.6 hours
Cure Through Time	24 hours
Useful Temp. Range	-54°C to 204°C (-75°F to 400°F)
Cured Properties - MECHANICAL	
Hardness	18 (Shore A)
Elongation	20 0%
Cured Properties - ELECTRICAL	
Volume Resistivity	1 x 10 ¹³ ohm · cm
Dielectric Strength	400 V/mil
Dielectric Constant	3.0 @ 1000 Hz

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Cured Properties - THERMAL	
Thermal Conductivity	0.17 W/m · °K
Brittle Point	-60°C (-75°F)
Thermal Expansion	-29 x 10 ⁻⁵ (°C) ⁻¹
Other	
Viscosity (@ 25°C)	1,300 cps
Mix Ratio (by weight)	20:1

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